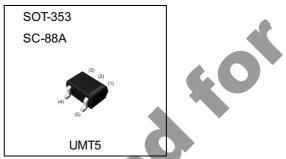


## PNP complex transistor with switching diode

Parameter	Value
V <sub>CEO</sub>	-50V
IC	-150mA

# Outline

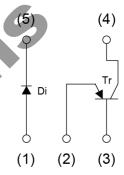


#### Features

1)The 2SA1774 and a diode are housed independently in a SOT-353 package.

## •Inner circuit

- (1) Di Anode
- (2) Tr Emitter
- (3) Tr Base
- (4) Tr Collector
- (5) Di Cathode



### Application

## Packaging specifications

<ul><li>Application</li><li>Low-frequency</li><li>Packaging spec</li></ul>	ifications			(4) Tr Collec (5) Di Catho		(1) (2)	(3)
Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
UML1N	SOT-353 (UMT5)	2021	TR	180	8	3000	L1

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

### Pin No.1-5 Diode

Parameter	Symbol	Value	Unit
Reverse voltage	$V_R$	80	V
Repetitive peak reverse voltage	$V_{RM}$	80	V
Average rectified current	I <sub>F</sub>	100	mA
Peak forward current	I <sub>FM</sub>	300	mA
Surge current	I <sub>surge</sub>	4	А
Rated in slash put frequency	f	100	MHz

### Pin No.2-3-4 Transistor

Parameter	Symbol	Value	Unit
Collector-base voltage	V <sub>CBO</sub>	-60	V
Collector-emitter voltage	V <sub>CEO</sub>	-50	V
Emitter-base voltage	V <sub>EBO</sub>	-6	V
Collector current	Ic	-150	mA

### **Each element**

Parameter	Symbol	Value	Unit
Power dissipation	P <sub>D</sub> *1,*2	150	mW/Total
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 <b>~</b> +150	°C

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

#### Pin No.1-5 Diode

Darameter	Cumphal	Symbol Conditions -		Values		
Parameter	Symbol			Тур.	Max.	Unit
Forward voltage	$V_{F}$	I <sub>F</sub> = 100mA	-	1	1.2	V
Reverse current	I <sub>R</sub>	V <sub>R</sub> = 70V	-		100	nA
Capacitance between terminals	$C_{T}$	V <sub>R</sub> = 6V , f = 1MHz	-	-	3.5	pF
Reverse recovery time	t <sub>rr</sub>	$V_R = 6V$ , $I_F = 5mA$ $R_L = 50\Omega$ (Figure 1)		<b>)</b>	4	ns

### Pin No.2-3-4 Transistor

Parameter	Symbol	Conditions	Values			Unit
raiametei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = -50μA	-60	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> =-1mA	-50	-	-	V
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = -50μA	-6	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -60V	-	-	-100	nA
Emitter cut-off current	I <sub>EBO</sub>	$V_{EB} = -5V$	-	-	-100	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -50$ mA, $I_B = -5$ mA	-	-	-500	mV
DC current gain	h <sub>FE</sub>	$V_{CE} = -6V, I_{C} = -1mA$	120	-	560	-
Transition frequency	f <sub>T</sub> *3	V <sub>CE</sub> = -12V, I <sub>E</sub> = 2mA, f = 100MHz	-	140	-	MHz
Output capacitance	C <sub>ob</sub>	$V_{CB} = -12V, I_{E} = 0A,$ f = 1MHz	-	4.0	5.0	pF

<sup>\*1</sup> Each termunal mounted on a reference land.

<sup>\*2 120</sup>mW per element must not be exceeded.

<sup>\*3</sup> Characteristics of built-in transistor.

## ● Electrical characteristic curves(Ta=25°C) < For Diode>

Fig.1 Reverse Current vs. Reverse Voltage

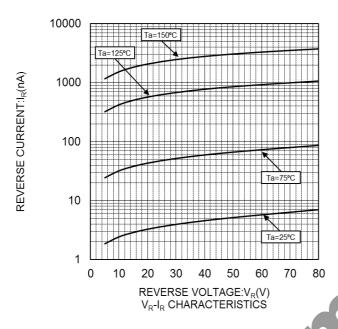


Fig.2 Forward Current vs. Forward Voltage

FORWARD CURRENT:IF(mA)

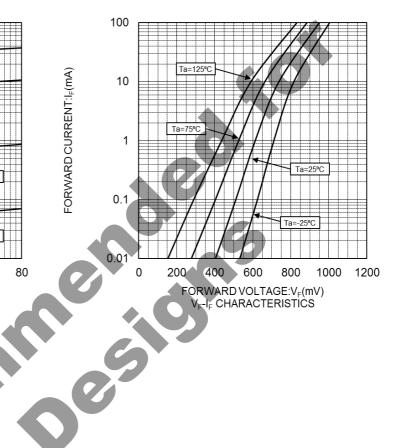
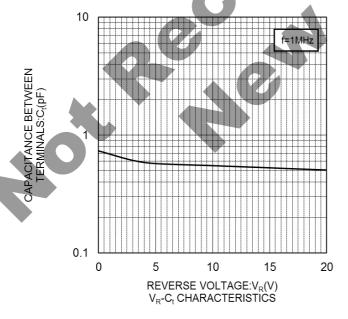
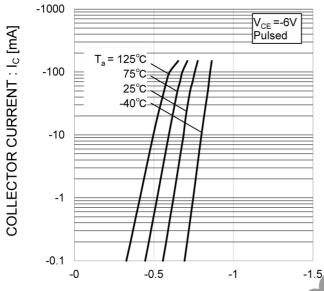


Fig.3 Capacitance Between Terminals vs. Reverse Voltage



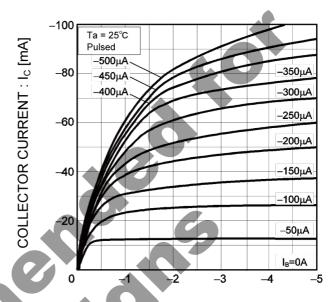
## ● Electrical characteristic curves(Ta=25°C) < For Transistor>

Fig.4 Ground Emitter Propagation Characteristics



BASE TO EMITTER VOLTAGE: VBE.[V]

Fig.5 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE :  $V_{CE}\left[V\right]$ 

Fig.6 DC Current Gain vs. Collector Current (I)

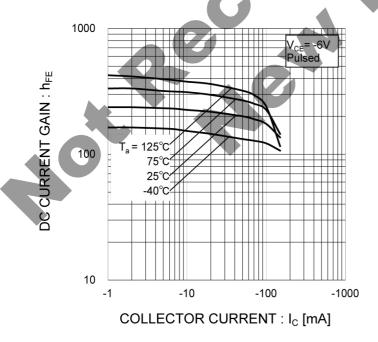
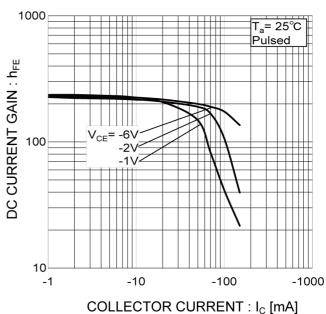


Fig.7 DC Current Gain vs. Collector Current (II)



## ● Electrical characteristic curves(Ta=25°C) < For Transistor>

Fig.8 Collector-Emitter Saturation Voltage vs. Collector Current (I)

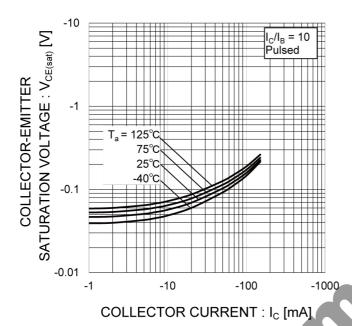
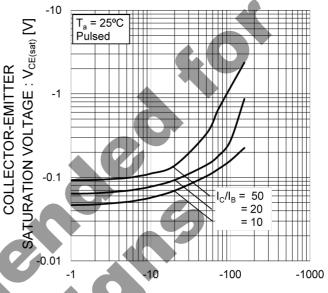


Fig.9 Collector-Emitter Saturation
Voltage vs. Collector Current (II)



COLLECTOR CURRENT : Ic [mA]

Fig.10 Base-Emitter Saturation Voltage vs. Collector Current

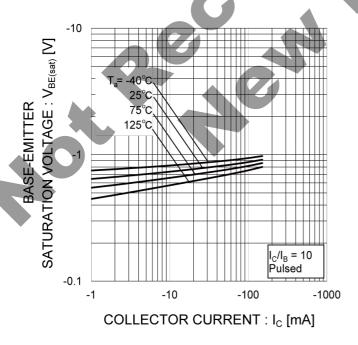
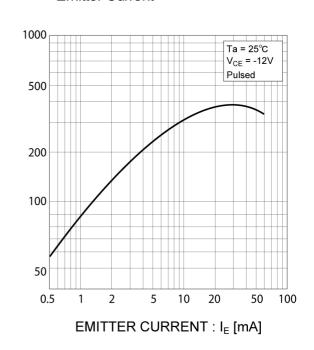


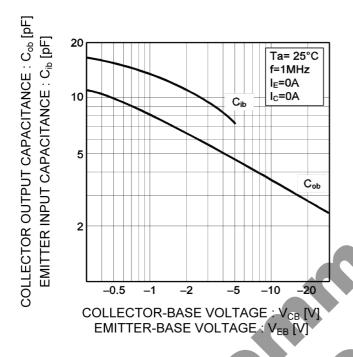
Fig.11 Gain Bandwidth Product vs. Emitter Current



TRANSITION FREQUENCY : fr [MHz]

## ● Electrical characteristic curves(T<sub>a</sub>=25°C) <For Transistor>

Fig.12 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

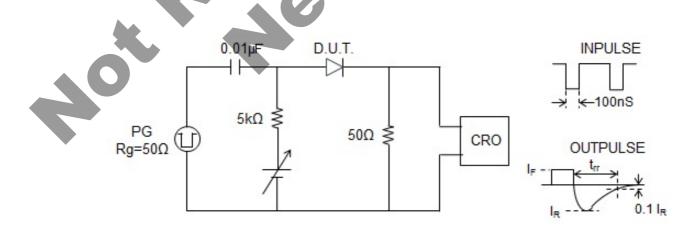


-1000 1ms 10ms 10ms 10ms 100ms 100ms

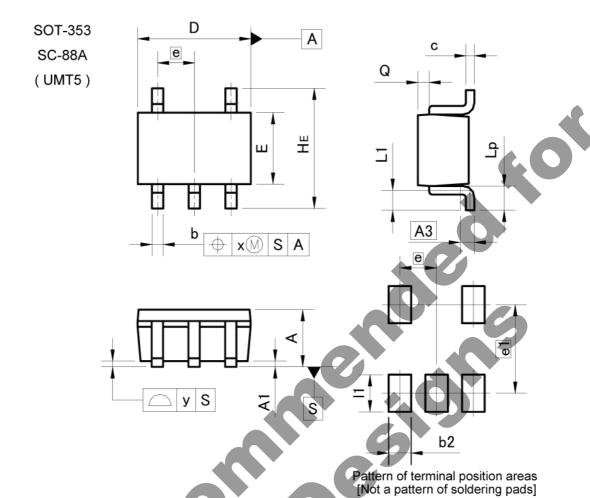
COLLECTOR TO EMITTER VOLTAGE :  $V_{\sf CE}$  [V]

Fig.13 Safe Operating Area

(figure 1) Reverse recovery time test circuit



## Dimensions



DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
e	0.	65	0.0	26
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
x	<del></del>	0.10	-	0.004
V	-	0.10	-	0.004

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	=	0.40	.=	0.016
e1	1.	55	0.0	61
l1	<del></del> 0	- 0.65		0.026

Dimension in mm/inches



Rev.003

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CLASSIV	CLASSⅢ	CLASSⅢ	CLASSII

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
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  - [h] Use of the Products in places subject to dew condensation
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
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